



## Material Content Data Sheet



<b>Sales Product Name</b>		BC 817K-25W H6327		<b>Issued</b>		2. August 2018		
<b>MA#</b>		MA000854890						
<b>Package</b>		PG-SOT323-3-1		<b>Weight*</b>		5.97 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	non noble metal	arsenic	7440-38-2	0.000	0.00		12	
	noble metal	gold	7440-57-5	0.007	0.12		1184	
	inorganic material	silicon	7440-21-3	0.060	1.01	1.13	10111	11307
leadframe	inorganic material	silicon	7440-21-3	0.001	0.01		88	
	non noble metal	titanium	7440-32-6	0.003	0.04		441	
	non noble metal	chromium	7440-47-3	0.008	0.13		1322	
	non noble metal	copper	7440-50-8	2.617	43.88	44.06	438690	440541
wire	non noble metal	copper	7440-50-8	0.005	0.09	0.09	905	905
encapsulation	organic material	carbon black	1333-86-4	0.031	0.52		5233	
	plastics	epoxy resin	-	0.671	11.25		112515	
	inorganic material	silicondioxide	60676-86-0	2.419	40.56	52.33	405576	523324
leadfinish	non noble metal	tin	7440-31-5	0.133	2.22	2.22	22245	22245
plating	noble metal	silver	7440-22-4	0.010	0.17	0.17	1678	1678
*deviation	< 10%		Sum in total:			100.00		1000000

### Important Remarks:

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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com